DESCRIPTION

The AM40T120B is available in TO-247 Package

VCES	IC	VCE	PD
1200V	40A	2.0V	357W

FEATURES

- Fast Switching
- Low V_{CE(sat): 2.0V}
- Positive Temperature Coefficient
- Very Soft, Fast Recovery Anti-Parallel Diode
- Irrm: 14.9A

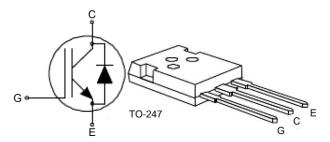
APPLICATION

- UPS
- Welding Converters
- Converters With High Switching Frequency

ORDERING INFORMATION

Package Type	Part Number			
TO-247	TL3F	AM40T120BTL3FU		
SPQ:30pcs/Tube	ILSF	AM40T120BTL3FVU		
Note	V: Halogen free Package			
Note	U: Tube			
AiT provides all RoHS products				

PIN DESCRIPTION



Pin#	Symbol Function	
1	G	Gate
2	С	Collector
3	E	Emitter

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Units			
Collector-Emitter Voltage	Vces	1200	V			
Collector Current @ Tc = 25 °C		80	Α			
Collector Current @ Tc = 100 °C	- Ic	40	Α			
Pulsed Collector Current (1) @ Tc = 25 °C	Ісм	160	Α			
Diode Continuous Forward Current @ Tc = 25 °C		40	Α			
Diode Continuous Forward Current @ Tc = 100 °C	- I _F	20	Α			
Diode Maximum Forward Current @ Tc = 25 °C	I _{FM}	160	Α			
Gate-Emitter Voltage	V _{GES}	±20	V			
Power Dissipation @ Tc = 25 °C	P _D	357	W			
Storage Temperature Range	T _{stg}	-55 to 150	°C			
Junction Temperature	TJ	150	°C			
Maximum Temperature for Soldering	TL	260	°C			
THERMAL CHARACTERISTICS						
Junction-to-Case (IGBT)	R _θ JC	0.34	°C/W			
Junction-to-Case (Diode)	R _{eJC}	0.8	°C/W			
Junction-to-Ambient	R _{θJA}	40	°C/W			

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Pulse width limited by maximum junction temperature

ELECTRICAL CHARACTERISTICS

T_A=25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
OFF CHARACTERISTICS							
Collector-Emitter Breakdown Voltage	Vces	V _{GE} =0V, I _C =250μA	1200	-	-	V	
Collector-Emitter Leakage Current	Ices	V _{CE} = 1200V, V _{GE} = 0V	-	-	250	μΑ	
Gate-Emitter Leakage Current	I _{GES(F)}	V _{GE} = +20V	-	-	600	nA	
Gate-Emitter Reverse Leakage	I _{GES(R)}	V _{GE} = -20V	-	-	-600	nA	
ON CHARACTERISTICS							
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} = 15V, I _C =40A	-	2.0	2.4	V	
Gate Threshold Voltage	V _{GE(TH)}	V _{CE} = V _{GE} , I _C = 1mA	5.5	5.8	6.5	V	
Pulse width tp≤300μs, δ≤2%							
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	V _{GE} = 0V	-	3633	-		
Output Capacitance	Coss	V _{CE} = 25V	-	150	-	рF	
Reverse Transfer Capacitance	Crss	f = 1.0MHz	-	90	-		
		I _C = 40A					
Total Gate Charge	Q_g	V _{CE} = 960V	-	270	-	nC	
		V _{GE} = 15V					
SWITCHING CHARACTERISTICS							
Turn-on Delay Time	t _{d(ON)}	I _C =40A	-	48	-		
Rise Time	t _r	V _{CE} = 600V	-	90	-		
Turn-Off Delay Time	t _{d(OFF)}	V _{GE} = 15V	-	275	-	ns	
Fall Time	t _f	R _G =10Ω	-	55	-		
Turn-On Switching Loss	Eon	Inductive Load	-	4.694	-		
Turn-Off Switching Loss	E _{off}		-	1.627	-	mJ	
Total Switching Loss	Ets		-	6.321	-		
DIODE CHARACTERISTICS							
Diode Forward Voltage	V _F	I _F =40A	-	2	2.5	V	
Reverse Recovery Time	T _{rr}	1 -404	-	73	-	nS	
Reverse Recovery Charge	Qrr	I _F =40A, di/dt=200A/us	-	654	-	nC	
Reverse Recovery Current	Irrm	ui/ut-zuuA/us	-	14.9	-	Α	

TYPICAL PERFORMANCE CHARACTERISTICS

Fig.1 Forward Bias Safe Operating Area

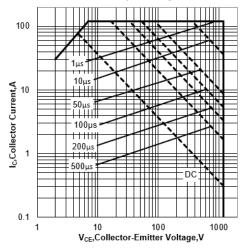


Fig.3 Collector Current vs Case Temperature

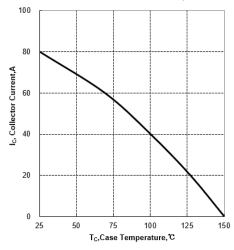


Fig.5 Typical Output Characteristics(Tc=25°C)

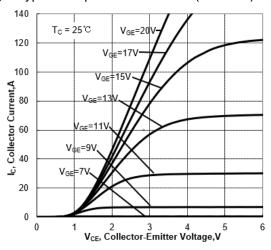


Fig.2 Power Dissipation vs Case Temperature

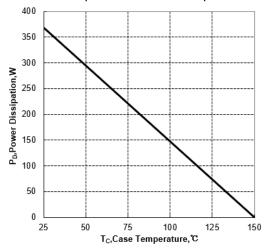


Fig.4 Typical Transfer Characteristics

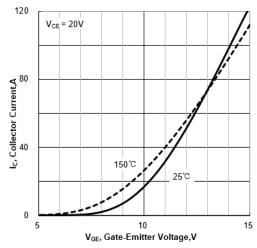
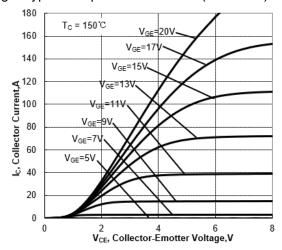
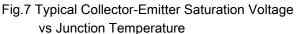


Fig.6 Typical Output Characteristics(T_C=150°C)





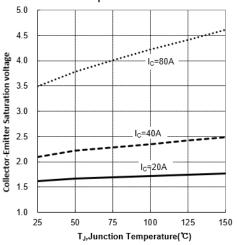


Fig.9 Typical Gate Charge

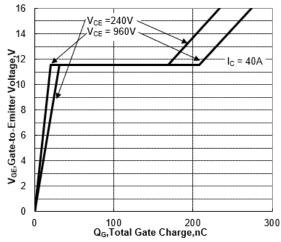


Fig.11 IGBT Transient Thermal Impedance vs Pulse Width

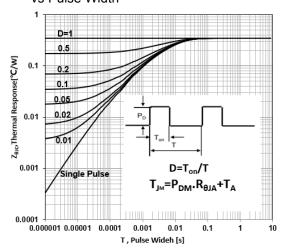


Fig.8 Typical Transfer Characteristics

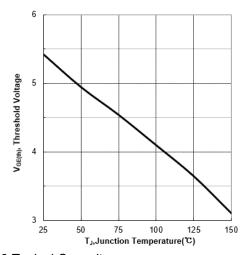


Fig.10 Typical Capacitance vs Collector- Emitter Voltage

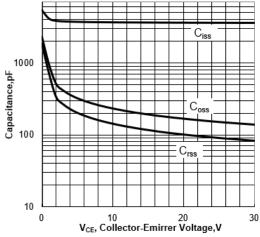
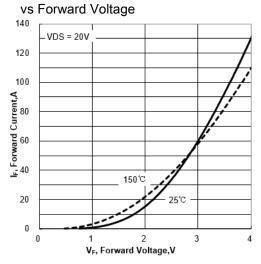
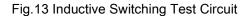


Fig.12 Typical Diode Forward Current





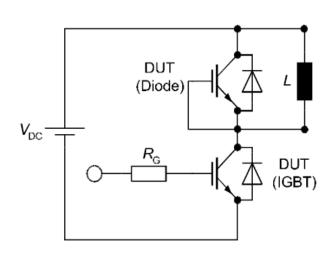


Fig.15 Inductive Switching Waveforms

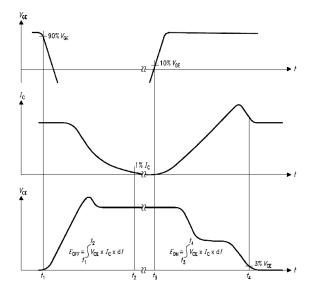


Fig.14 Inductive Switching Waveforms

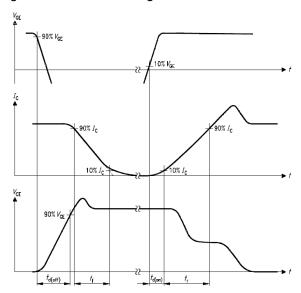
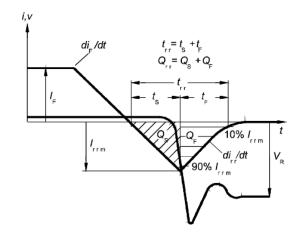
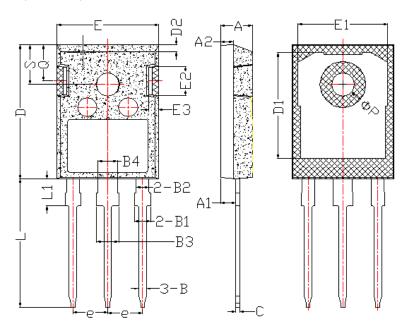


Fig.16. Inductive Switching Waveforms



PACKAGE INFORMATION

Dimension in TO-247 (Unit: mm)



Symbol	Min.	Max.	Symbol	Min.	Max.
Α	4.900	5.160	D2	1.050	1.350
A1	2.270	2.530	Е	15.700	16.030
A2	1.850	2.110	E1	13.100	14.150
В	1.070	1.330	E2	3.680	5.100
B1	1.900	2.410	E3	1.680	2.600
B2	1.750	2.150	e	5.440	
В3	2.870	3.380	L	19.800	20.310
B4	2.870	3.130	L1	4.170	4.470
С	0.550	0.680	ΦР	3.500	3.700
D	20.820	21.100	Q	5.490	6.000
D1	16.250	17.650	S	6.040	6.300

AM40T120B MOSFET 1200V, 40A, Irrm=14.9A IGBT MOSFET

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